

P20B12SLK

Power MOSFETs
120V, 20A, N-channel

Feature

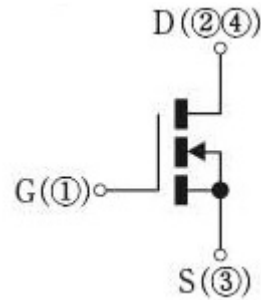
- N-channel
- SMD
- Low Ron
- 4.5V Gate Drive
- Low Capacitance
- Based on AEC-Q101
- Halogen free • Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): FB
Package (JEDEC Code): TO-252AA



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T _{stg}		-55 to 175	°C
Channel temperature	T _{ch}		-55 to 175	°C
Drain-source voltage	V _{DSS}		120	V
Gate-source voltage	V _{GSS}		±20	V
Continuous drain current(DC)	I _D		20	A
Continuous drain current(Peak)	I _{DP}	Pulse width 10μs, duty=1/100	60	A
Continuous source current(DC)	I _S		20	A
Total power dissipation	P _T	With heatsink ※	46	W
Total power dissipation	P _T	Measured on the 1 inch ² glass epoxy substrate pattern area : 586.81mm ²	3.3	W
Total power dissipation	P _T	Measured on the 1 inch ² glass epoxy substrate pattern area : 102.19mm ²	2	W
Single avalanche current	I _{AS}	Starting T _{ch} =25°C T _{ch} ≤150°C	18	A
Single avalanche energy	E _{AS}	Starting T _{ch} =25°C T _{ch} ≤150°C	37	mJ

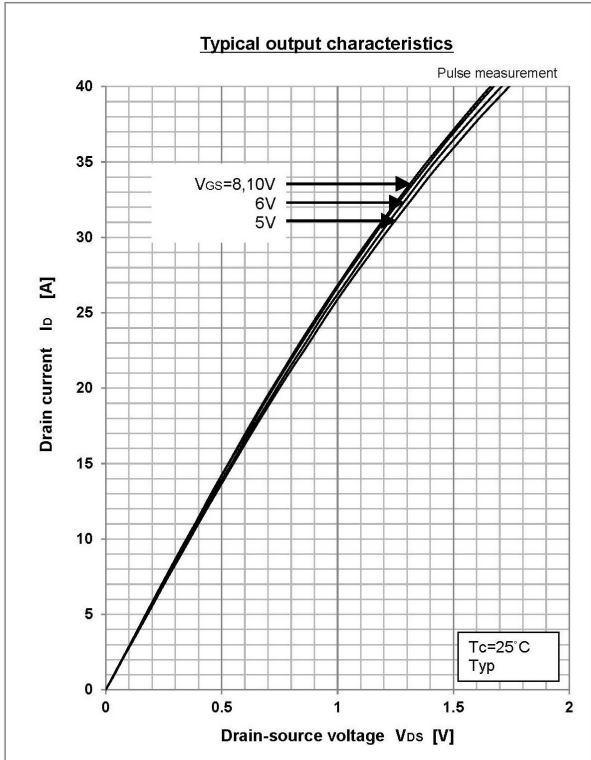
※ :See the original Specifications

Electrical Characteristics (unless otherwise specified : Tc=25°C)

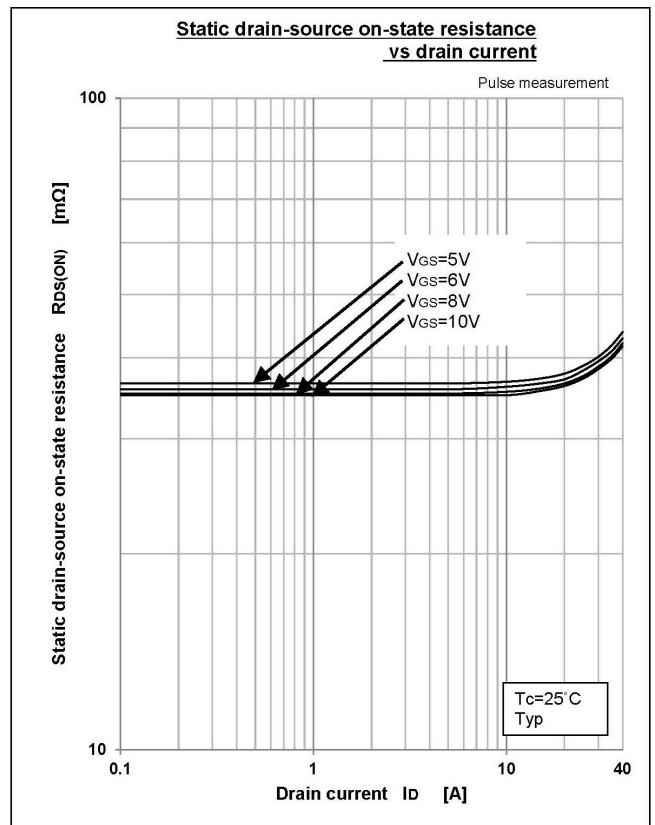
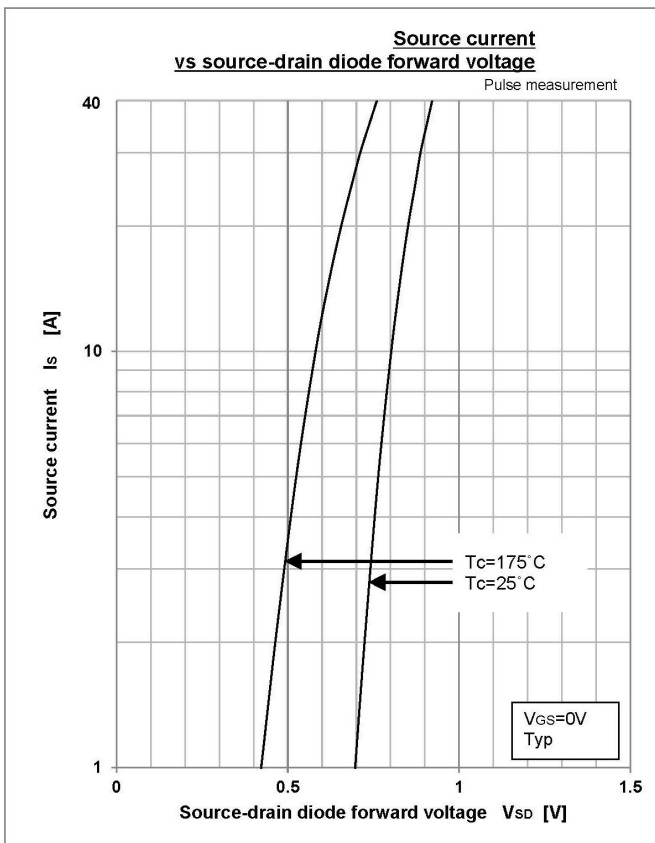
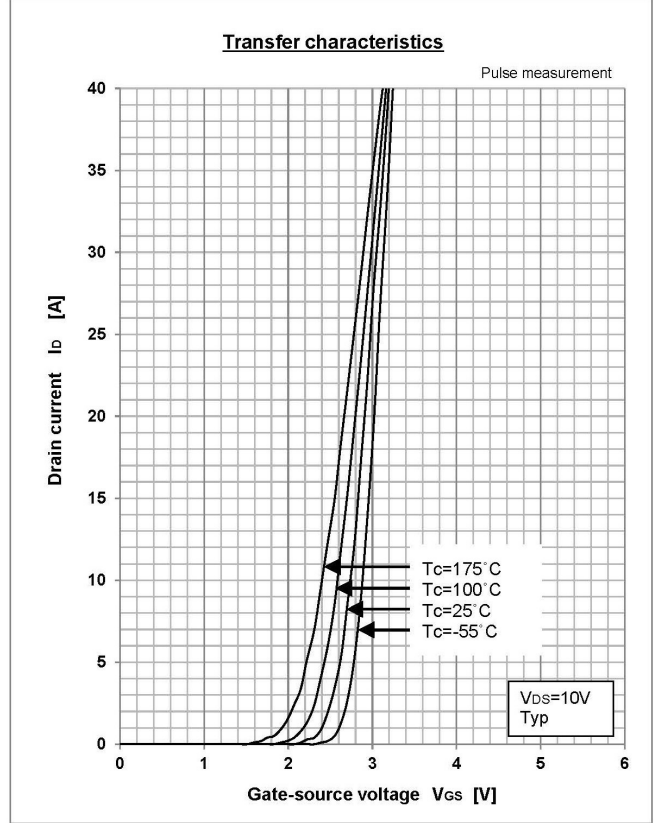
Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Drain-Source breakdown voltage	$V_{(BR)DSS}$	ID=1mA, VGS=0V	120			V
Zero gate voltage drain current	I_{DSS}	VDS=120V, VGS=0V			1	μA
Gate-source leakage current	I_{GSS}	VGS=±20V, VDS=0V			±0.1	μA
Forward transconductance	g_{fs}	ID=10A, VDS=10V	8			S
Static drain-source on-state resistance	$R_{DS(ON)}$	ID=10A, VGS=10V		0.035	0.044	Ω
Static drain-source on-state resistance	$R_{DS(ON)}$	ID=10A, VGS=4.5V		0.037	0.05	Ω
Gate threshold voltage	Vth	ID=1mA, VDS=10V	1.5	2	2.5	V
Source-drain diode forward voltage	V_{SD}	IS=20A, VGS=0V			1.5	V
Thermal resistance	Rth(j-c)	Junction to case, with heatsink ※			3.2	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient Measured on the 1 inch ² glass epoxy substrate pattern area : 586.81mm ²			45	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient Measured on the 1 inch ² glass epoxy substrate pattern area : 102.19mm ²			75	°C/W
Total gate charge	Qg	VDD=96V, VGS=10V, ID=20A		46		nC
Gate to source charge	Qgs	VDD=96V, VGS=10V, ID=20A		8		nC
Gate to drain charge	Qgd	VDD=96V, VGS=10V, ID=20A		12		nC
Input capacitance	Ciss	VDS=25V, VGS=0V, f=1MHz		2110		pF
Reverse transfer capacitance	Crss	VDS=25V, VGS=0V, f=1MHz		73		pF
Output capacitance	Coss	VDS=25V, VGS=0V, f=1MHz		140		pF
Turn-on delay time	td(on)	ID=10A, RL=6Ω, VDD=60V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		6		ns
Rise time	tr	ID=10A, RL=6Ω, VDD=60V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		9		ns
Turn-off delay time	td(off)	ID=10A, RL=6Ω, VDD=60V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		32		ns
Fall time	tf	ID=10A, RL=6Ω, VDD=60V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		18		ns
Diode reverse recovery time	trr	IF=20A, VGS=0V, di/dt=100A/μs		57		ns
Diode reverse recovery charge	Qrr	IF=20A, VGS=0V, di/dt=100A/μs		120		nC

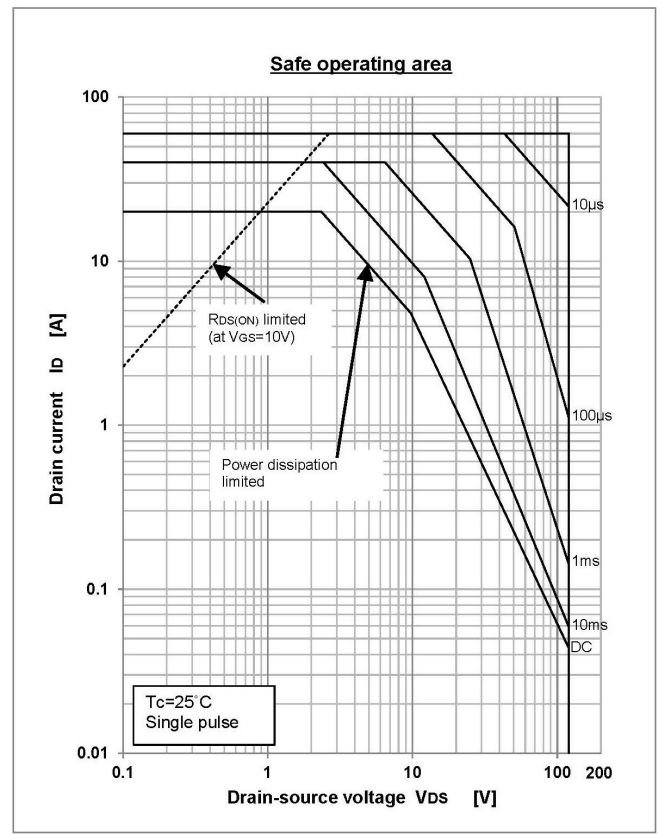
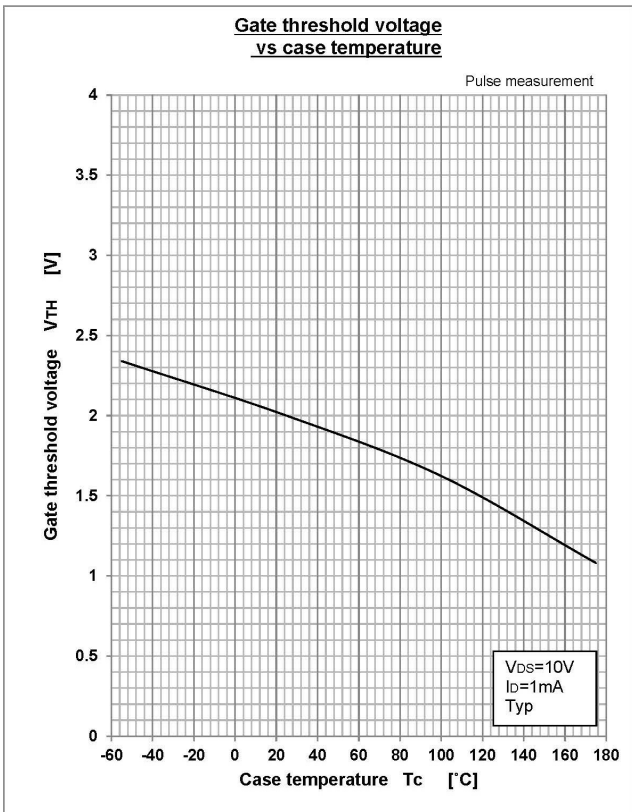
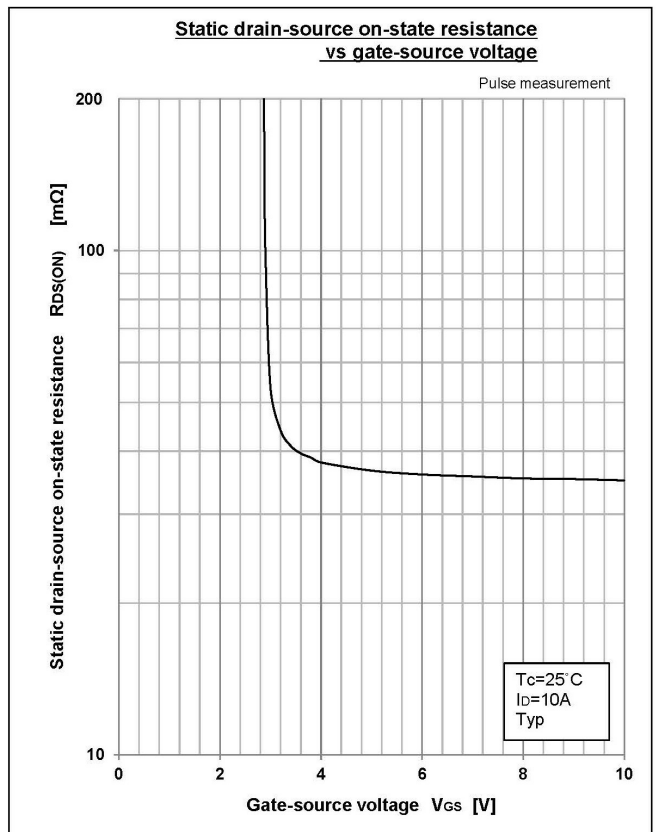
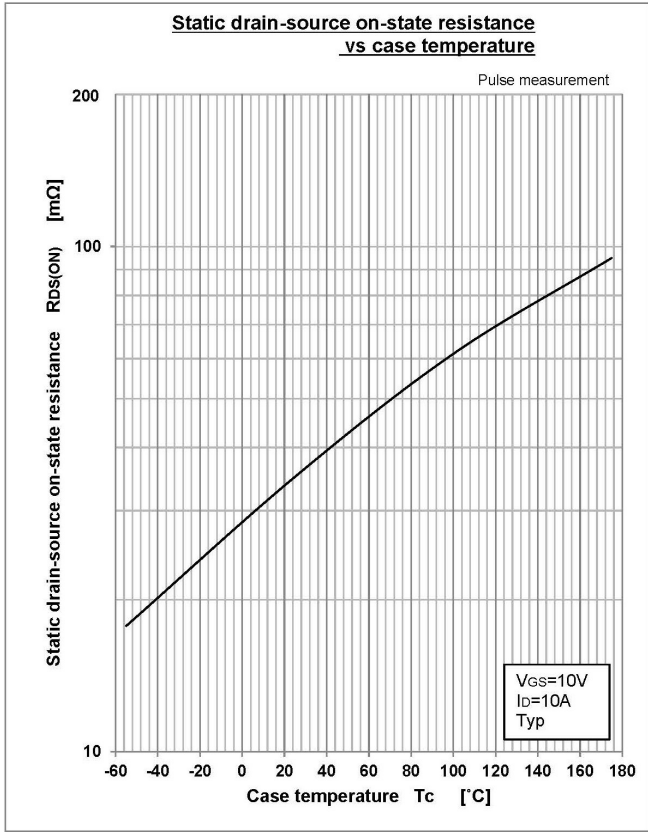
※ :See the original Specifications

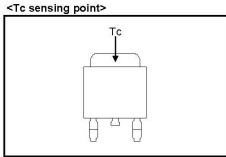
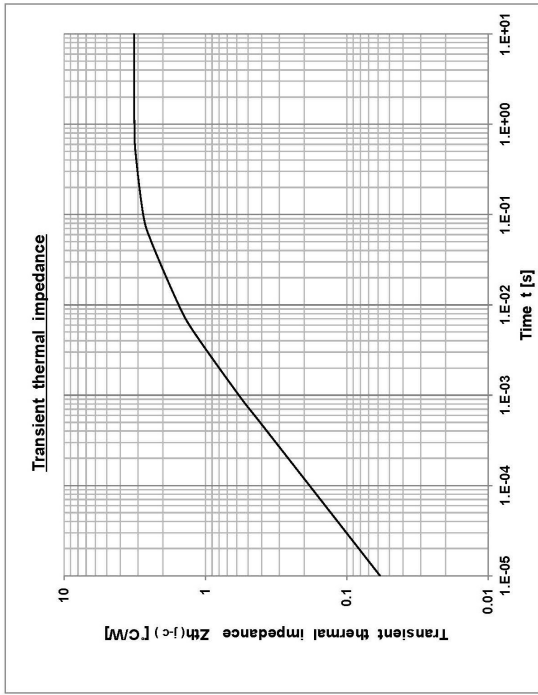
CHARACTERISTIC DIAGRAMS



Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



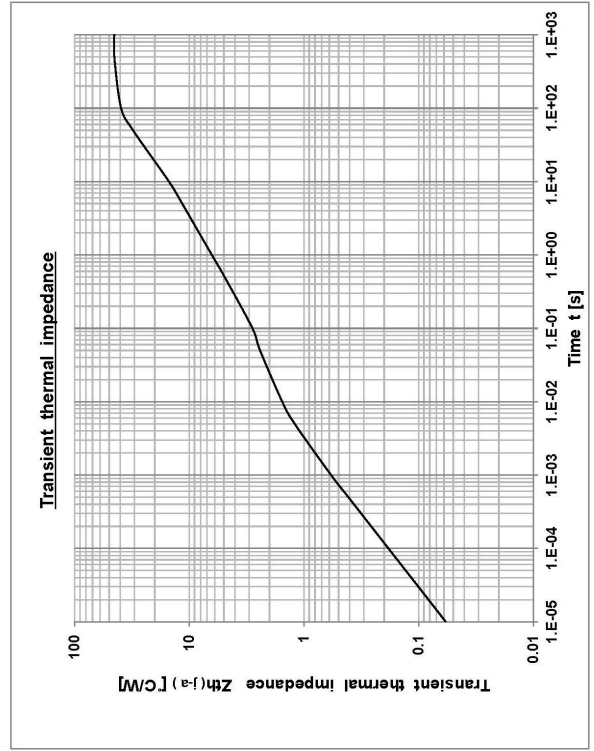




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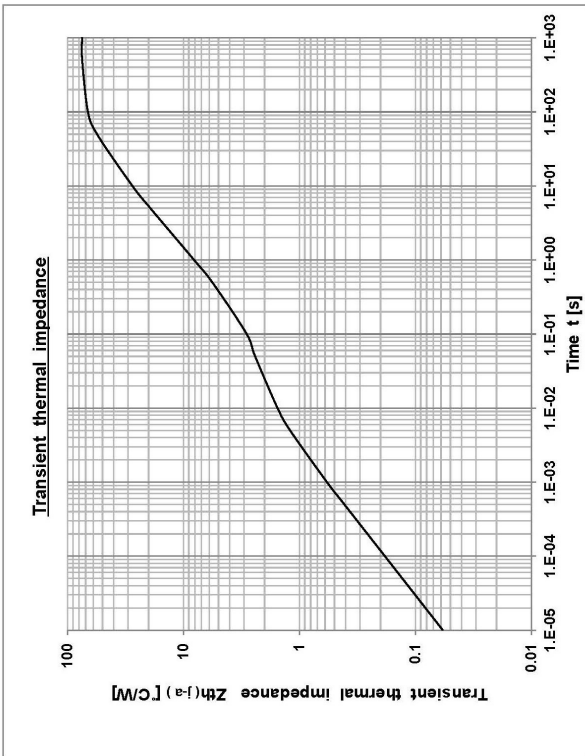
Type	Alumina
Size	1 inch ²
Thickness	0.84 mm
Conductor thickness	20 μm
Pattern area	65 mm ²

Specification No. **50E 2A9028 4**



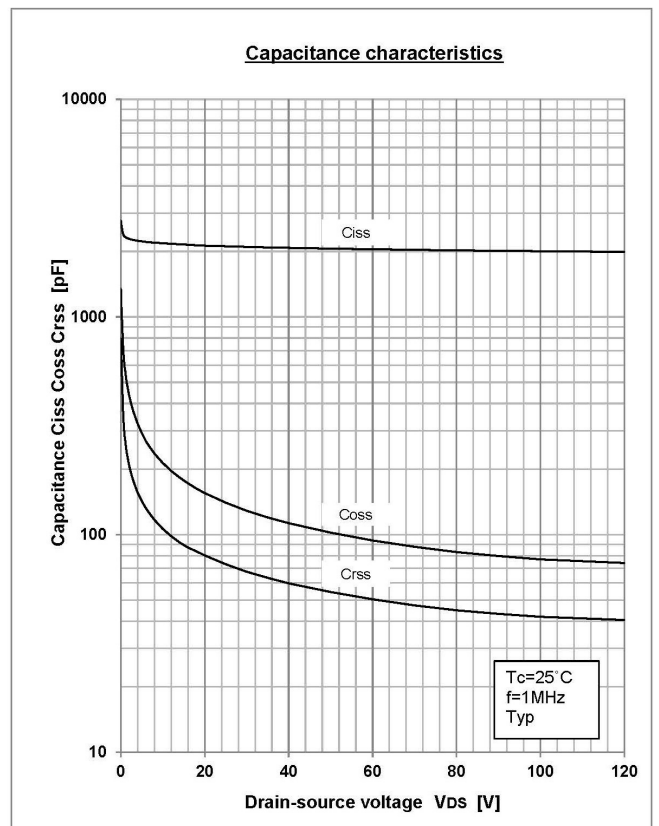
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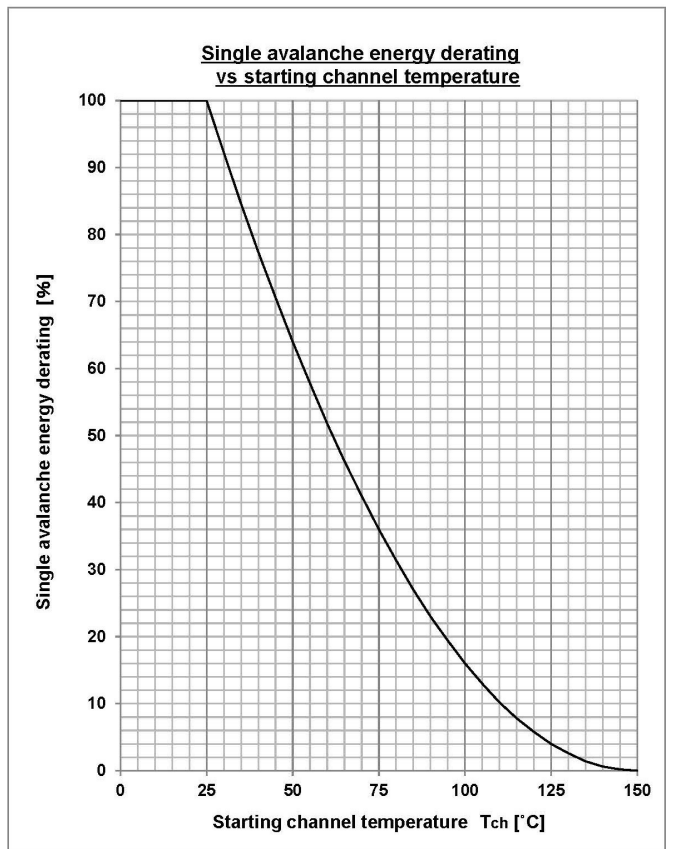
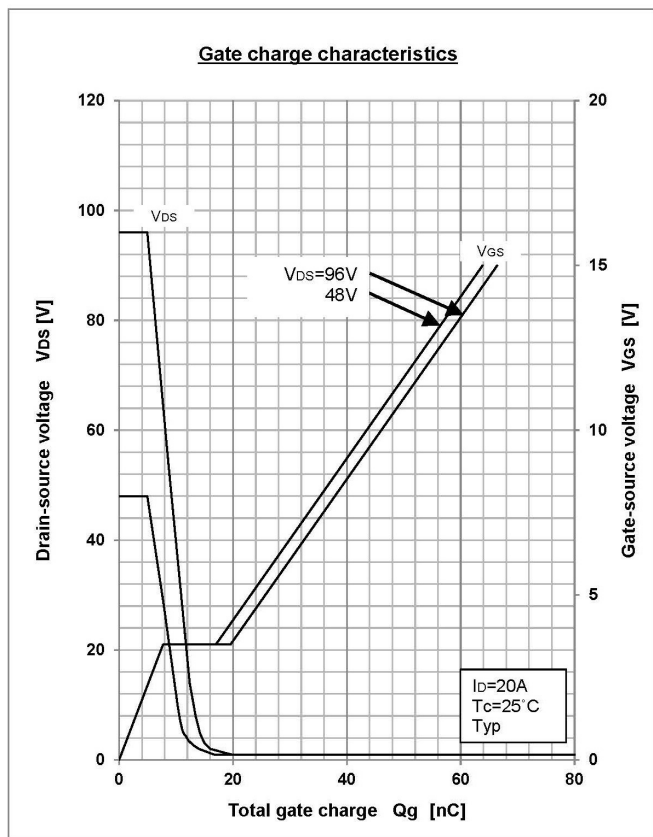
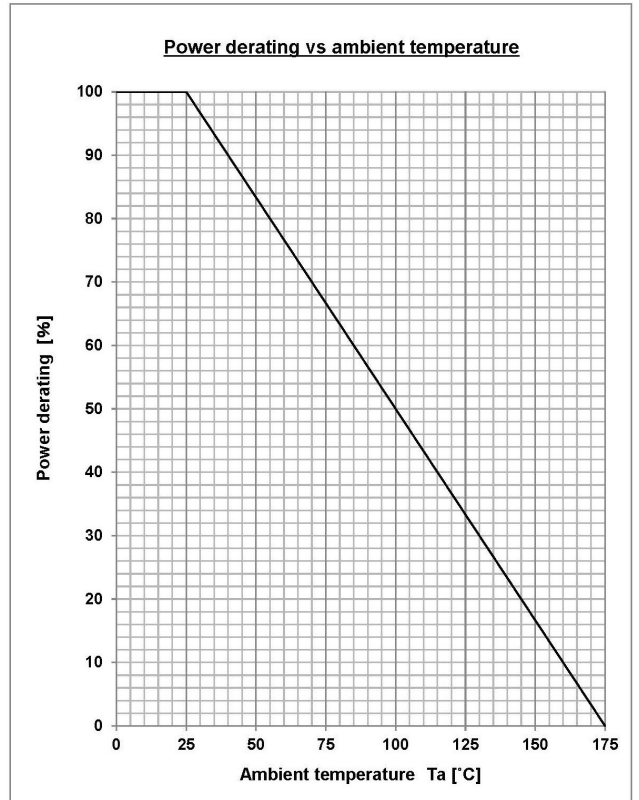
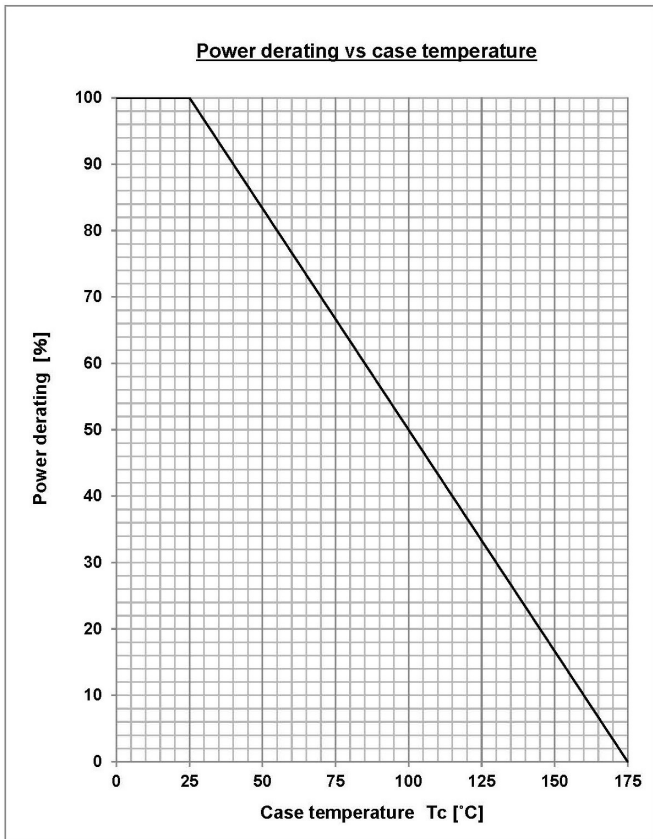
Type	Glass-epoxy
Size	1 inch ²
Thickness	1.6 mm
Conductor thickness	70 μm
Pattern area	586.81 mm ²



<Substrate detail>

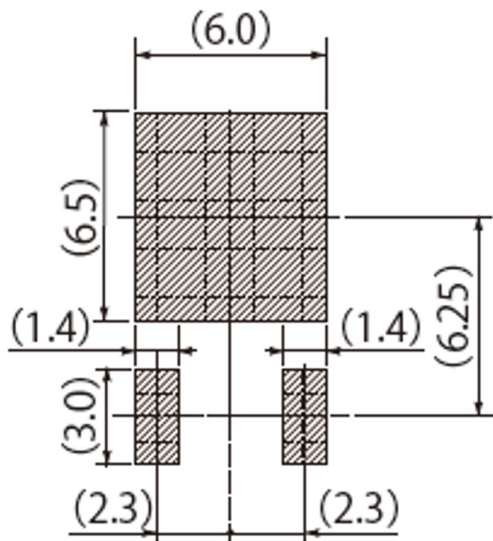
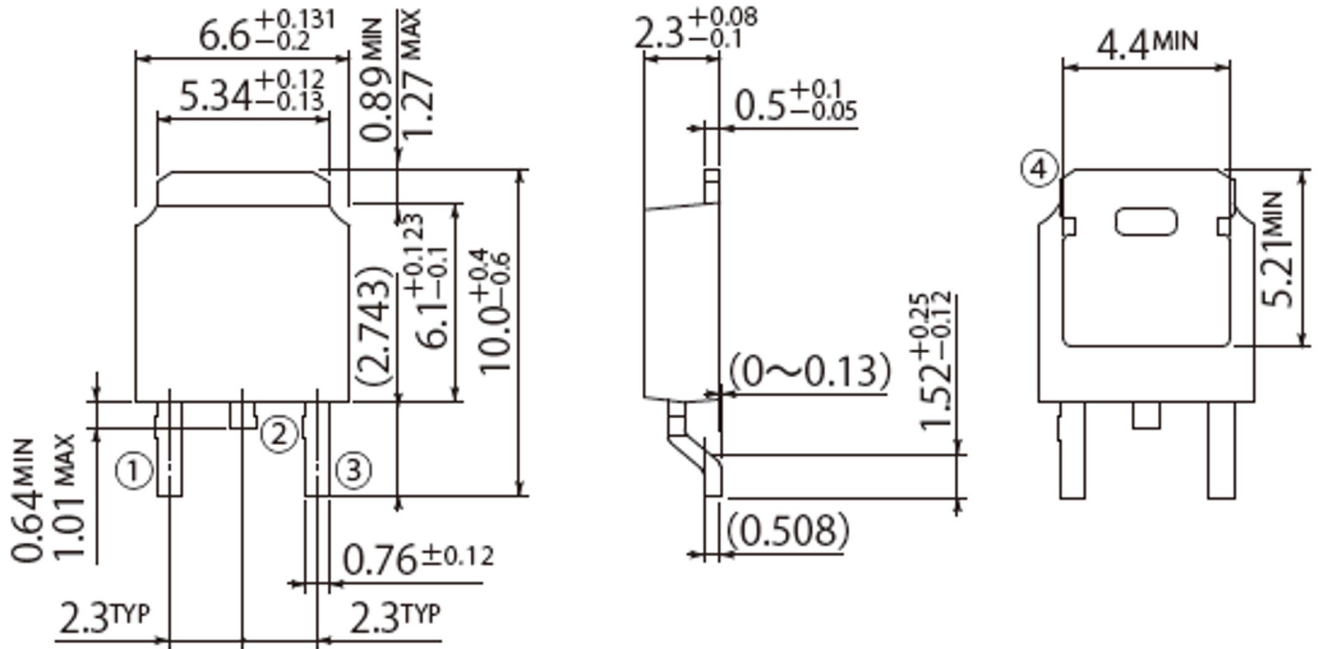
Type	Glass-epoxy
Size	1 inch ²
Thickness	1.6 mm
Conductor thickness	70 μm
Pattern area	102.19 mm ²





G2

JEDEC Code	TO-252AA
JEITA Code	-
House Name	FB



Referential Soldering Pad

Notes

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